

N-Channel 800V (D-S) Super Junction Power MOSFET

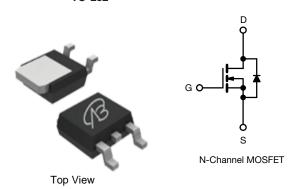
| PRODUCT SUMMARY | | | | | |
|--|------------------------|-------|--|--|--|
| V _{DS} (V) at T _J max. | 800 | | | | |
| R _{DS(on)} typ. (Ω) at 25 °C | V _{GS} = 10 V | 0.380 | | | |

FEATURES

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)







APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

| ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted) | | | | | | |
|--|-------------------------|---|-----------------------------------|-------------|------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | | V_{DS} | 800 | V | |
| Gate-source voltage | | | V_{GS} | ± 30 | V | |
| Continuous drain current (T. – 150 °C) | V at 10 V | $T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$ | - I _D | 11 | | |
| Continuous drain current (T _J = 150 °C) | V _{GS} at 10 V | T _C = 100 °C | | 6.5 | Α | |
| Pulsed drain current ^a | | | I _{DM} | 33 | | |
| Linear derating factor | | | | 1.7 | W/°C | |
| Single pulse avalanche energy b | | E _{AS} | 350 | mJ | | |
| Maximum power dissipation | | | P_{D} | 180 | W | |
| Operating junction and storage temperature range | | | T _J , T _{stg} | -55 to +150 | °C | |
| Drain-source voltage slope | T _J = 125 °C | | dV/dt 50 | 50 | V/ns | |
| Reverse diode dV/dt ^d | | αν/αι | 5.1 | V/115 | | |
| Soldering recommendations (peak temperature) c | e) c For 10 s | | | 260 | °C | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 100 V, starting T_J = 25 °C, L = 30 mH, R_g = 25 Ω , I_{AS} = 5A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$

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| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|-------------------|------|------|--------------|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | |
| Maximum junction-to-ambient | R _{thJA} | = | 62 | °C/W | | |
| Maximum junction-to-case (drain) | R _{thJC} | - | 0.85 | G/ VV | | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|---|------|-------|-------|------|
| Static | | • | | | | | |
| Drain-source breakdown voltage | V _{DS} | V _{GS} = 0 V, I _D = 250 μA | | 800 | _ | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | Reference to 25 °C, I _D = 1 mA | | 1.08 | - | V/°C |
| Gate-source threshold Voltage (N) | V _{GS(th)} | V _{DS} = | V _{DS} = V _{GS} , I _D = 250 μA | | - | 4.0 | V |
| 0.1 | _ | V _{GS} = ± 20 V | | - | - | ± 100 | nA |
| Gate-source leakage | I _{GSS} | $V_{GS} = \pm 30 \text{ V}$ $V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ $V_{GS} = 10 \text{ V} \qquad I_{D} = 3.5 \text{A}$ $V_{DS} = 30 \text{ V}, I_{D} = 5 \text{ A}$ $V_{DS} = 100 \text{ V}, V_{DS} = 100 \text{ V}$ | - | - | ± 1 | μΑ | |
| 7 | | | | - | - | 1 | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 640 \ | /, V _{GS} = 0 V, T _J = 125 °C | - | - | 10 | μA |
| Drain-source on-state resistance | R _{DS(on)} | | | - | 0.380 | - | Ω |
| Forward transconductance | 9 _{fs} | V_{DS} | = 30 V, I _D = 5 A | - | 8.7 | - | S |
| Dynamic | | • | | | | | |
| Input capacitance | C _{iss} | | Vcc = 0 V | - | 1900 | - | - |
| Output capacitance | C _{oss} | | $V_{DS} = 100 \text{ V},$ | - | 51 | - | |
| Reverse transfer capacitance | C _{rss} | | f = 1 MHz | | 12 | - | pF |
| Effective output capacitance, energy related ^a | C _{o(er)} | V 0V 400 V V 0V | | - | 40 | - | |
| Effective output capacitance, time related ^b | C _{o(tr)} | V _{DS} = 0 \ | V _{DS} = 0 V to 480 V, V _{GS} = 0 V | | 205 | - | |
| Total gate charge | Qg | | | - | 25 | - | |
| Gate-source charge | Q _{gs} | V _{GS} = 10 V | $V_{GS} = 10 \text{ V}$ $I_D = 5 \text{ A}, V_{DS} = 480 \text{ V}$ | | 8 | - | nC |
| Gate-drain charge | Q_{gd} | | | | 10 | - | |
| Turn-on delay time | t _{d(on)} | V _{DD} = 480 V, I _D = 5 A, | | - | 12 | 24 | |
| Rise time | t _r | | | - | 14 | 23 | |
| Turn-off delay time | t _{d(off)} | V _{GS} | = 10 V, $R_g = 9.1 \Omega$ | - | 61 | 110 | ns |
| Fall time | t _f | | g g | | 16 | - | |
| Gate input resistance | R_g | f = 1 | f = 1 MHz, open drain | | 0.7 | 1.4 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous source-drain diode current | Is | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 11 | |
| Pulsed diode forward current | I _{SM} | | | - | - | 33 | - A |
| Diode forward voltage | V _{SD} | T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V | | - | - | 1.2 | V |
| Reverse recovery time | t _{rr} | T _J = 25 °C, I _F = I _S = 5 A, dl/dt = 100 A/μs, V _R = 25 V | | - | 416 | 832 | ns |
| Reverse recovery charge | Q _{rr} | | | - | 6.4 | 12.8 | μC |
| Reverse recovery current | I _{RRM} | | | - | 27 | - | Α |

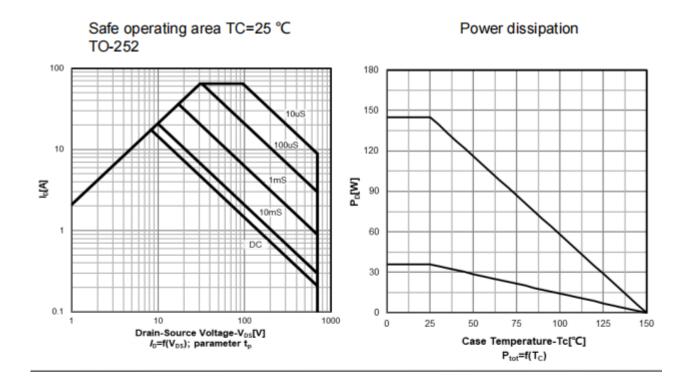
Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

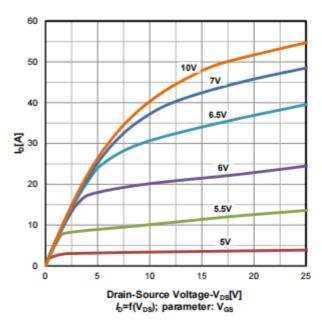
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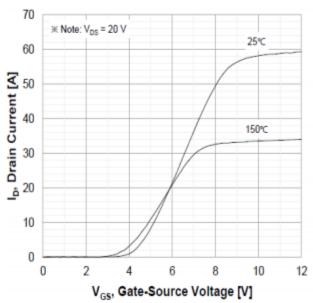
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Typ. output characteristics T_i =25 $^{\circ}C$



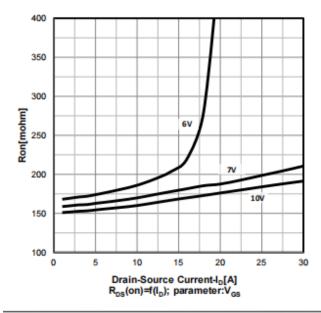
Transfer characteristics



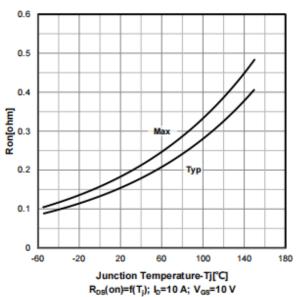
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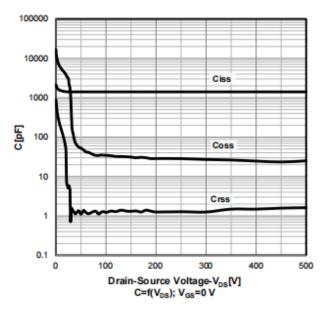
Typ. drain-source on-state resistance



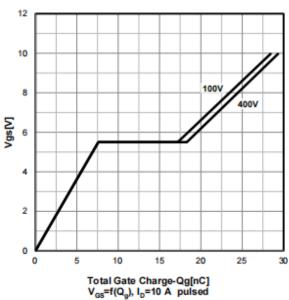
On-resistance vs temperature



Typ. capacitances



Typ. gate charge characteristics

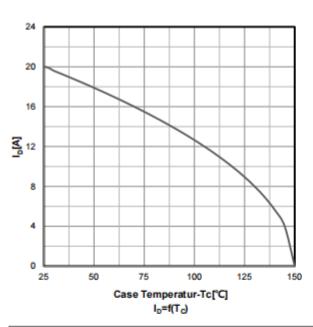


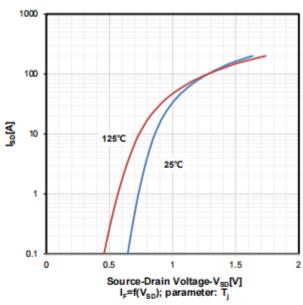
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Drain current vs temperature

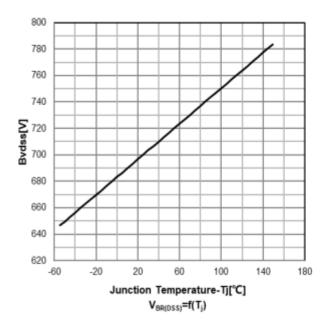
Forward characteristics of reverse diode

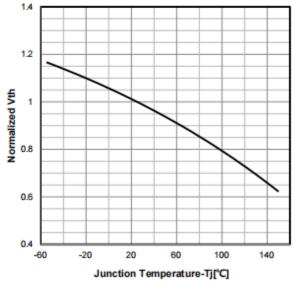




Drain-source breakdown voltage

Normalized $V_{\text{GS}(\text{th})}$ characteristics

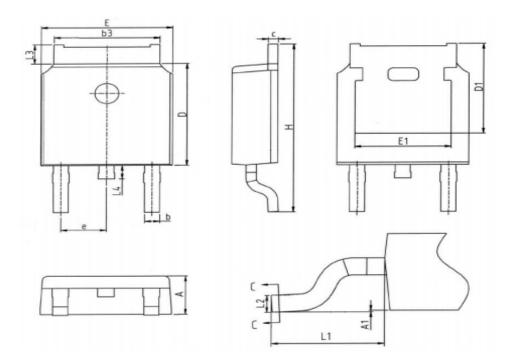




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Package Outline: TO 252



COMMON DIMENSIONS

| COMMISSION DESIGNATION | | | | | | |
|------------------------|----------|-------|-------|--|--|--|
| SYMBOL | UNIT(mm) | | | | | |
| SIMBOL | MIN | NOM | MAX | | | |
| A | 2.20 | 2.30 | 2.40 | | | |
| A1 | 0.00 | - | 0.127 | | | |
| b | 0.66 | 0.78 | 0.90 | | | |
| b3 | 5.16 | 5.31 | 5.46 | | | |
| c | 0.43 | 0.53 | 0.63 | | | |
| D | 5.98 | 6.10 | 6.22 | | | |
| D1 | 5.30REF | | | | | |
| E | 6.40 | 6.75 | | | | |
| E1 | 4.63 | - | - | | | |
| e | 2.286BSC | | | | | |
| H | 9.40 | 10.10 | 10.50 | | | |
| L1 | 2.90REF | | | | | |
| L2 | 0.51BSC | | | | | |
| L3 | 0.88 | 1.08 | 1.28 | | | |
| L4 | 0.50 | 0.80 | 1.00 | | | |

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